

1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER
Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- **Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)**
- **"Green" Device (Note 4)**

Mechanical Data

- Case: SOD-123
- Plastic Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity: Cathode Band
- Leads: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating) Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.01 grams (approximate)



Top View

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	40	V
Working Peak Reverse Voltage @ $I_R = 1.0\text{mA}$	V_{RWM}		
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(RMS)}$	28	V
Average Rectified Output Current @ $T_L = 90^\circ\text{C}$	I_O	1.0	A
Repetitive Peak Forward Current $t_p \leq 1\text{ms}, \delta \leq 0.5$	I_{FRM}	1.5	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	25	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	P_D	450	mW
Typical Thermal Resistance Junction to Ambient (Note 2)	$R_{\theta JA}$	222	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +125	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 3)	$V_{(BR)R}$	40	—	—	V	$I_R = 1.0\text{mA}$
Forward Voltage	V_F	—	—	0.320	V	$I_F = 0.1\text{A}$
		—	—	0.450		$I_F = 1.0\text{A}$
		—	—	0.750		$I_F = 3.0\text{A}$
Reverse Leakage Current (Note 3)	I_R	—	—	1.0	mA	$V_R = 40\text{V}, T_A = 25^\circ\text{C}$
		—	—	10		$V_R = 40\text{V}, T_A = 100^\circ\text{C}$
		—	10	50	μA	$V_R = 4\text{V}, T_A = 25^\circ\text{C}$
		—	1	2		$V_R = 4\text{V}, T_A = 100^\circ\text{C}$
		—	15	75	μA	$V_R = 6\text{V}, T_A = 25^\circ\text{C}$
		—	1.5	3		$V_R = 6\text{V}, T_A = 100^\circ\text{C}$
Total Capacitance	C_T	—	50	60	pF	$V_R = 4\text{V}, f = 1.0\text{MHz}$

- Notes:
1. No purposefully added lead. Halogen and Antimony Free.
 2. Device mounted on FR-4 PC Board, 2"x2", 2 oz. Copper, single sided, Cathode pad dimensions 0.75"x1.0", Anode pad dimensions 0.25"x1.0".
 3. Short duration pulse test used to minimize self-heating effect.
 4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb_2O_3 Fire Retardants.

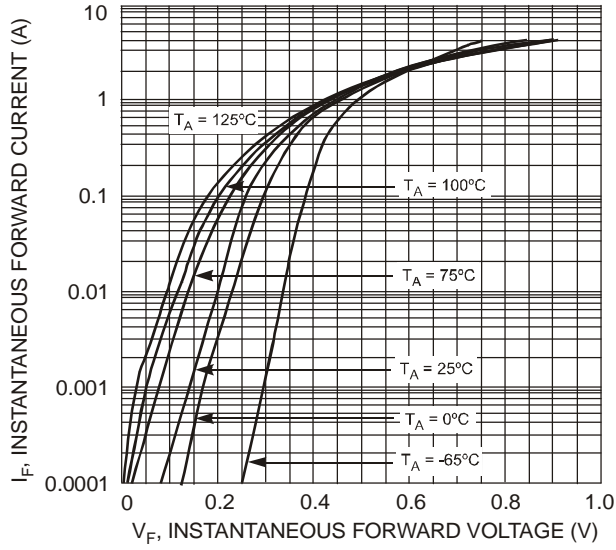


Fig. 1 Typical Forward Characteristics

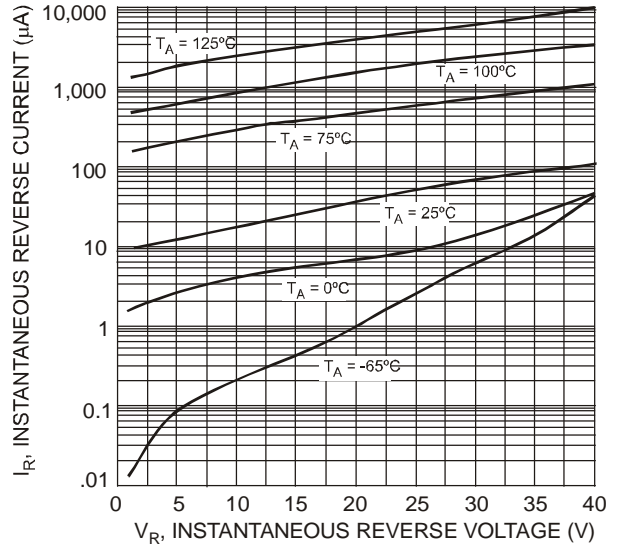


Fig. 2 Typical Reverse Characteristics

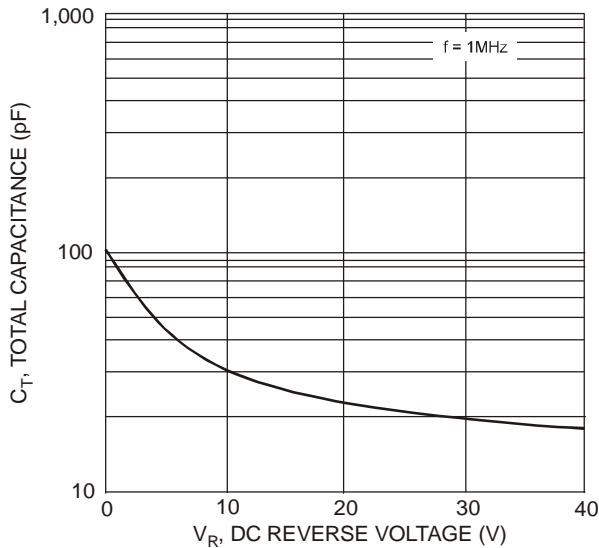


Fig. 3 Total Capacitance vs. Reverse Voltage

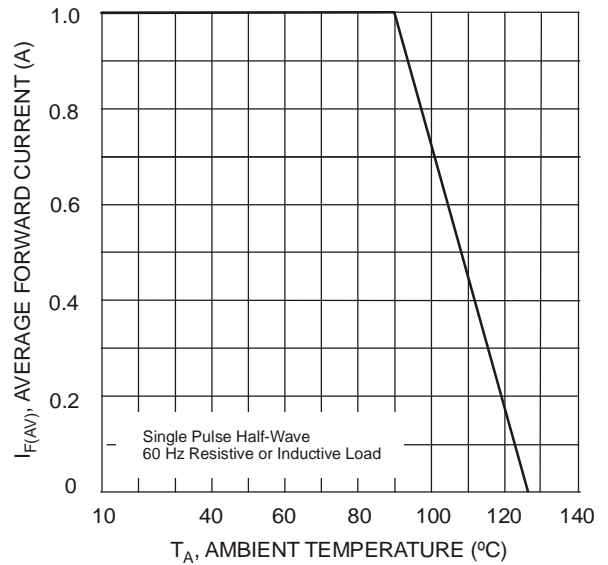


Fig. 4 Forward Current Derating Curve

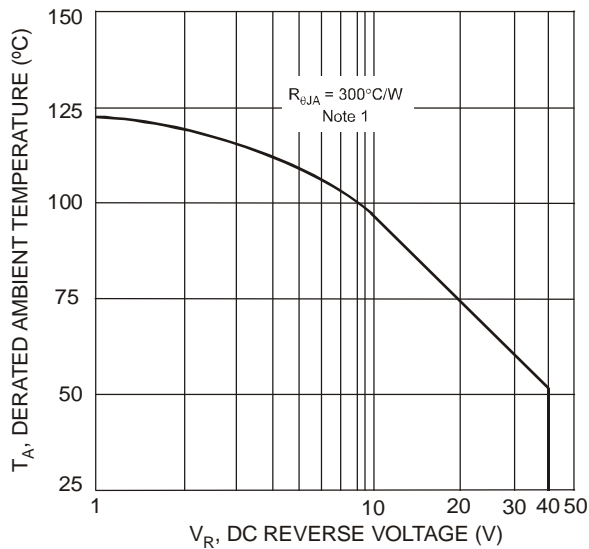


Fig. 5 Operating Temperature Derating

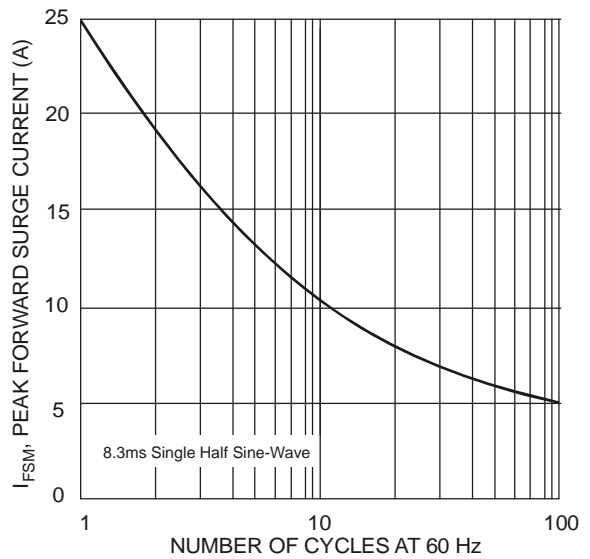


Fig. 6 Maximum Non-Repetitive Peak Forward Surge Current

Ordering Information (Note 5)

Part Number	Case	Packaging
1N5819HW-7-F	SOD-123	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



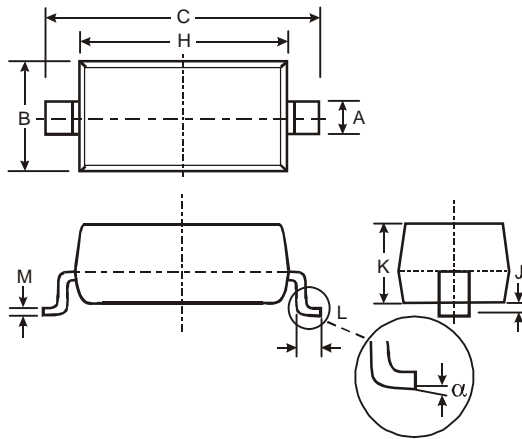
SL = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: N = 2002)
 M = Month (ex: 9 = September)

Date Code Key

Year	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	N	P	R	S	T	U	V	W	X	Y	Z

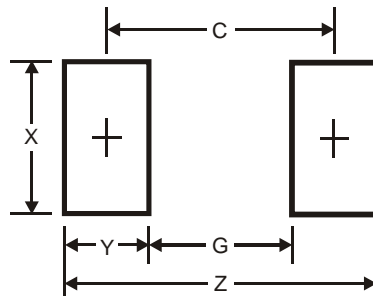
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Package Outline Dimensions



SOD-123		
Dim	Min	Max
A	0.55 Typ	
B	1.40	1.70
C	3.55	3.85
H	2.55	2.85
J	0.00	0.10
K	1.00	1.35
L	0.25	0.40
M	0.10	0.15
α	0	8°
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
Z	4.9
G	2.5
X	0.7
Y	1.2
C	3.7

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